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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/020,034	12/07/2001	Jozef D. Mitros	TI-32931	8951
23494 7	9590 09:02:2003			
TEXAS INSTRUMENTS INCORPORATED P O BOX 655474, M/S 3999 DALLAS, TX 75265			EXAMINER	
			PHAM, LONG	
			ART UNIT	PAPER NUMBER
			2814	
			DATE MAILED: 09/02/2003	

Please find below and/or attached an Office communication concerning this application or proceeding.

				1K		
		Application No.	Applicant(s)	7 T		
Office Action Summary		10/020,034	MITROS ET AL.			
		Examiner	Art Unit			
		Long Pham	2814			
Period fo	The MAILING DATE of this communication ap or Reply	pears on the cover sheet	with the correspondence addre	ss		
THE - Exte after - If the - If NO - Failu - Any	ORTENED STATUTORY PERIOD FOR REPL MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1. SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a rep. D period for reply is specified above, the maximum statutory period ure to reply within the set or extended period for reply will, by statut reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may oly within the statutory minimum of will apply and will expire SIX (6) May be cause the application to become	y a reply be timely filed thirty (30) days will be considered timely. MONTHS from the mailing date of this comm a ABANDONED (35 U.S.C. § 133).	unication.		
1)	Responsive to communication(s) filed on	·				
2a)[This action is FINAL . 2b)∑ T	his action is non-final.				
3)	Since this application is in condition for allow closed in accordance with the practice under ion of Claims	vance except for formal in FEX parte Quayle, 1935	matters, prosecution as to the n C.D. 11, 453 O.G. 213.	nerits is		
•	Claim(s) <u>1-30</u> is/are pending in the application	on.				
→/	4a) Of the above claim(s) is/are withdra					
5)[·]	Claim(s) <u>1-17 and 28-30</u> is/are allowed.					
•	Claim(s) <u>18,19,26 and 27</u> is/are rejected.					
•	Claim(s) <u>20-25</u> is/are objected to.					
•	Claim(s) are subject to restriction and/	or election requirement.				
	tion Papers					
•	The specification is objected to by the Examin					
10)	The drawing(s) filed on is/are: a) ☐ acc					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
11)	The proposed drawing correction filed on		disapproved by the Examiner.			
	If approved, corrected drawings are required in r					
· ·	The oath or declaration is objected to by the E	xaminer.				
	under 35 U.S.C. §§ 119 and 120		0.0.440(-).(-)(5)			
13)	Acknowledament is made of a claim for foreign	gn priority under 35 U.S	.C. § 119(a)-(d) or (i).			
		nts have been received.				
			in Application No.			
				age		
*	3. Copies of the certified copies of the pr application from the International E See the attached detailed Office action for a lie	Bureau (PCT Rule 17.2(a	a)).			
	Acknowledgment is made of a claim for dome:			pplication).		
	a) The translation of the foreign language packnowledgment is made of a claim for dome	provisional application ha	as been received.			
Attachme						
2) Not	tice of References Cited (PTO-892) tice of Draftsperson's Patent Drawing Review (PTO-948) ormation Disclosure Statement(s) (PTO-1449) Paper No(s	5) Notic	view Summary (PTO-413) Paper No(s) be of Informal Patent Application (PTO- r:			

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DETAILED ACTION

Claim Rejections - 35 USC § 103

1. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

1. Claims 18 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lin et al (US '082) in view of Nakahara (US '242) (a newly cited reference).

With respect to clams 18, Lin teaches a method of fabricating MOSFET transistors in a semiconductor device, comprising (see figures 1, 2A-2F, and 3A-3E and col. 1, line 10 to col.7, line 5):

providing a semiconductor substrate 220;

adjusting a threshold voltage 226 of a first transistor device 208 (NMOS) in a first region of said substrate by a first implantation process; and forming a source/drain region 250 of a second transistor device 210 (PMOS) by a second implantation process.

However, Lin et al. fails to teach adjusting the threshold voltage of the first transistor device and forming the source/drain of the second transistor device in single implantation or simultaneous implantation.

Nakahar teaches a process of forming multiple MOS devices on a substrate in which the threshold voltage region of a MOS device and the source/drain

See figures 1A-1E and 2A-2B, 3, and 4 and col. 1, line 5 to col. 6, line 55. It would have been obvious to *one of ordinary skill in the art of making semiconductor devices* to form the threshold voltage region of the first transistor device and the source/drain or LDD region of the second transistor device simultaneously or in a single implantation step in Lin's method because in doing so high-speed MOS devices can be obtained. See col. 1, lines 54-60.

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With respect to claim 19, Lin et al. further teach forming a source/drain region 250 of the first transistor device. See fig. 2F.

2. Claims 26 and 27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lin et al (US '082) in view of Nakahara (US '242) (a newly cited reference).

Lin teaches a method of forming a source/drain region in a semiconductor device, comprising (see figures 1, 2A-2F, and 3A-3E and col. 1, line 10 to col.7, line 5):

implanting a first transistor region using boron or phosphorus to adjust a threshold voltage associated with the first transistor device 208 by a first implantation process; and

implanting a portion of a second transistor region using boron or phosphorus to form a source/drain region 250 associated with a second transistor device 212 by a second implantation process.

Lin teaches that the threshold voltage region of the first transistor device and the source/drain of the second transistor device are formed by two separate implantation processes but fails to teach that the threshold voltage region of the first transistor device and the source/drain region of the second transistor device are formed by a single implantation process as recited in present claim 26.

Makariai todorios a process at the

in which the threshold voltage region of a MOS device and the source/drain regions of another MOS device are formed simultaneously by implantation. See figures 1A-1E and 2A-2B, 3, and 4 and col. 1, line 5 to col. 6, line 55. It would have been obvious to *one of ordinary skill in the art of making semiconductor devices* to form the threshold voltage region of the first transistor device and the source/drain or LDD region of the second transistor device simultaneously or in a single implantation step in Lin's method

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because in doing so high-speed MOS devices can be obtained. See col. 1, lines 54-60.

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Allowable Subject Matter

3. Claims 1-17 and 28-30 are allowed.

Allowable Subject Matter

4. Claims 20, 21, 22, 23, 24, and 25 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Long Pham whose telephone number is 703-308-1092. The examiner can normally be reached on M-F, 8:30AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 703-308-4918. The fax phone numbers for the organization where this application or proceeding is assigned are 703-746-4082 for regular communications and 703-746-4082 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be allocated as a second seco

Long Pham

Primary Examiner

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L. P.

August 27, 2003